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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### **AIGaAs Infrared Emitting Diode**

#### **FEATURES**

- T-1 package
- 15° (nominal) beam angle
- 880 nm wavelength
- · Consistent optical properties
- Higher output than GaAs at equivalent drive current
- Mechanically and spectrally matched to SDP8405 phototransistor and SDP8105 photodarlington

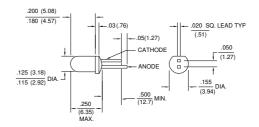


#### DESCRIPTION

The SEP8705 is an aluminum gallium arsenide infrared emitting diode transfer molded in a T-1 smoke gray plastic package. Transfer molding of this device assures superior optical centerline performance compared to other molding processes. These devices typically exhibit 70% greater power intensity compared to GaAs devices at the same forward current. Lead lengths are staggered to provide a simple method of polarity identification.

#### **OUTLINE DIMENSIONS** in inches (mm)

Tolerance 3 plc decimals ±0.005(0.12) ±0.020(0.51) 2 plc decimals



DIM\_101.ds4



### **AIGaAs Infrared Emitting Diode**

### ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)

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PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Irradiance (1)	Н				mW/cm <sup>2</sup>	I <sub>F</sub> =20 mA
SEP8705-001		0.54				
SEP8705-002		1.4		5.6		
SEP8705-003		2.7		7.8		
Forward Voltage	VF			1.7	V	I <sub>F</sub> =20 mA
Reverse Breakdown Voltage	$V_{BR}$	3.0			V	I <sub>R</sub> =10 μA
Peak Output Wavelength	$\lambda_p$		880		nm	
Spectral Bandwidth	$\Delta \lambda$		80		nm	
Spectral Shift With Temperature	$\Delta \lambda_p / \Delta_T$		0.2		nm/°C	
Beam Angle (2)	Ø		15		degr.	I <sub>F</sub> =Constant
Radiation Rise And Fall Time	t <sub>r</sub> , t <sub>f</sub>		0.7		μs	

- Notes

  1. Measured in mW/cm² into a 0.081(2.05) diameter aperture placed 0.40(10.16) from the lens tip.

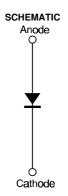
  2. Beam angle is defined as the total included angle between the half intensity points.

#### **ABSOLUTE MAXIMUM RATINGS**

(25°C Free-Air Temperature unless otherwise noted) Continuous Forward Current 70 mW (1) Power Dissipation Operating Temperature Range -40°C to 85°C -40°C to 85°C Storage Temperature Range Soldering Temperature (5 sec)

#### Notes

1. Derate linearly from 25°C free-air temperature at the rate of 0.18 mW/°C.



### **AIGaAs Infrared Emitting Diode**

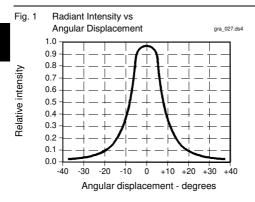
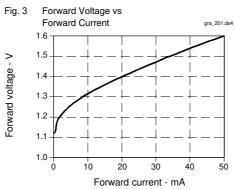
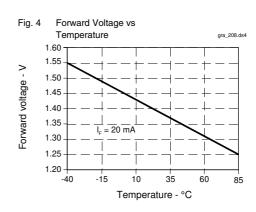
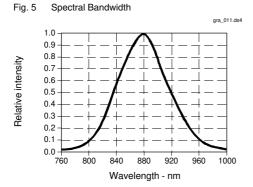
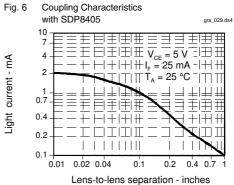


Fig. 2 Radiant Intensity vs Forward Current gra\_028.ds4 10.0 Normalized radiant intensity П 2.0 1.0 0.5  $\Pi\Pi\Pi$ 0.2 0.1 10 20 30 40 50 100 Forward current - mA

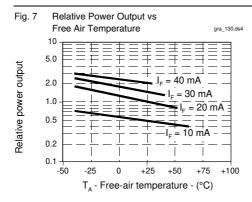








### **AlGaAs Infrared Emitting Diode**



All Performance Curves Show Typical Values